

# LTspice Model

## Photocoupler

### LITE-ON Technology Corporation.

### LTV-356T-TP1-B

#### Model Information

**Model** A macro model  
**Call Name** MDC\_LTV-356T-TP1-B\_LT  
**Pin Assign** 1:Anode 2:Cathode 3:Emitter 4:Collector  
**File List** Model Library MDC\_LTV-356T-TP1-B\_LT.lib  
 Model Report MDC\_LTV-356T-TP1-B\_LT.pdf(this file)

#### Verified Simulator Version

#### Note

#### References

The information which was used for modeling is as follow:

##### [Data Sheet]

- Date/Version 10/27/2016 / RNC-OD-FC002/A4
- Product name LTV-356T
- Company name LITE-ON Technology Corporation.

##### [Characteristics listed]

- Characteristics
  - VCE(sat)-IF
  - IF-VF
  - CTR-IF
  - IC-VCE
  - Response Time-Load Resistance

#### Simulation Condition

This table shows the range of evaluated simulation range that was not occurs any convergence problems in this area.

Item	Condition	Unit
Temperature	25	deg C

○ : Implemented  
× : Not Implemented  
— : Not applicable

**Model Functions Table**
**RANK=1**

Functions	RANK	Implemented
IF-VF-Temp	1	○
Iout-Vout-IF	1	○
Iout-IF	1	—
Iout/IF-IF(CTR-IF)	1	○
CJ-VR	1	—
Propagation delay	1	○
Switching (Typ.)	1	○

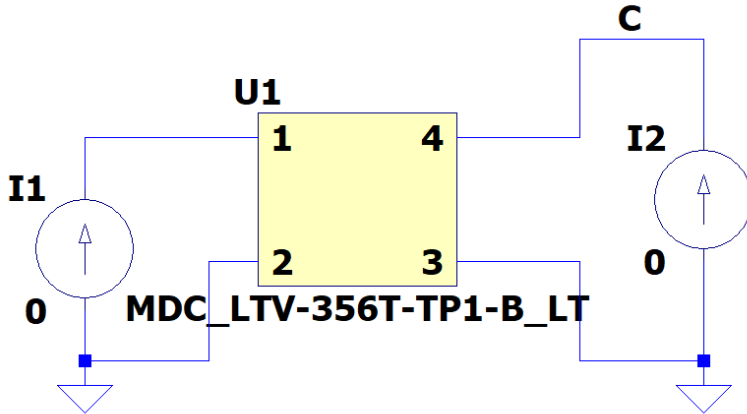
VCE(sat)-IF Testbench

Referred to Data Sheet

**.OPTION TNOM=25**

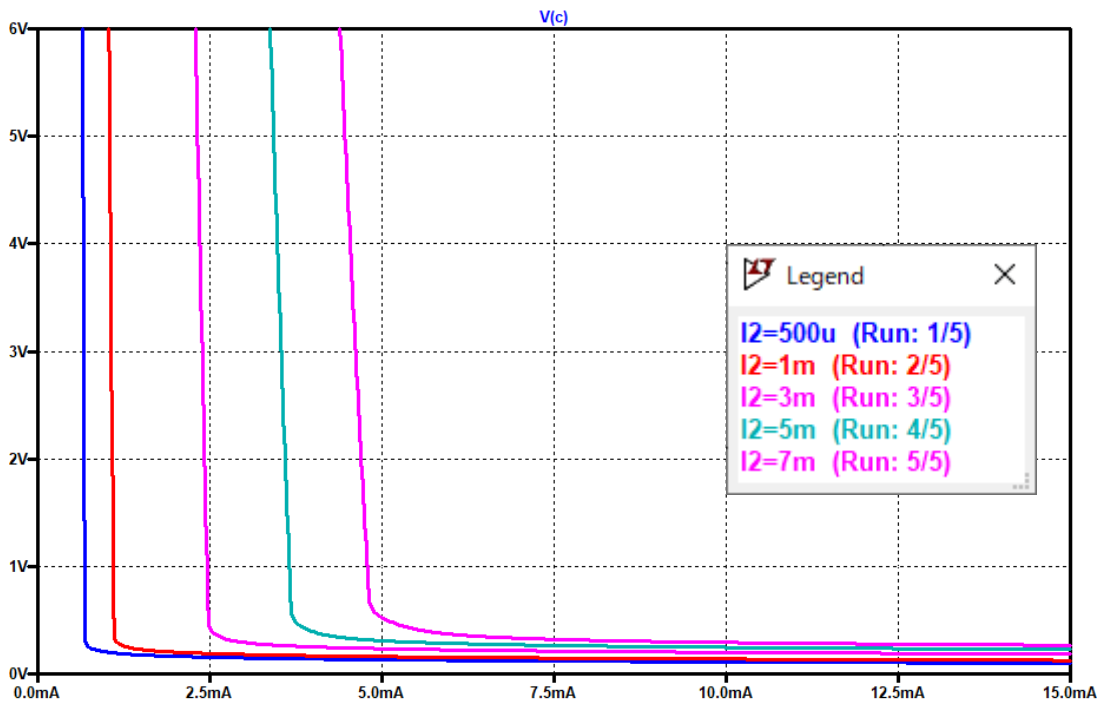
**.TEMP=25**

**.dc I1 0 15m 0.01m I2 list 0.5m 1m 3m 5m 7m**



Simulation results are following.  
Explanatory notes — : simulated

VCE(sat)-IF

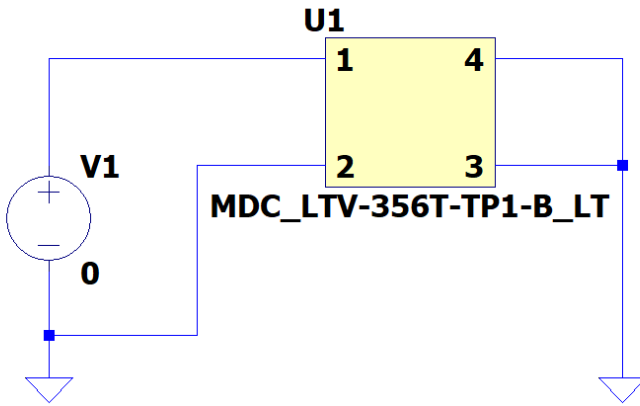


IF-VF Testbench

Referred to Data Sheet

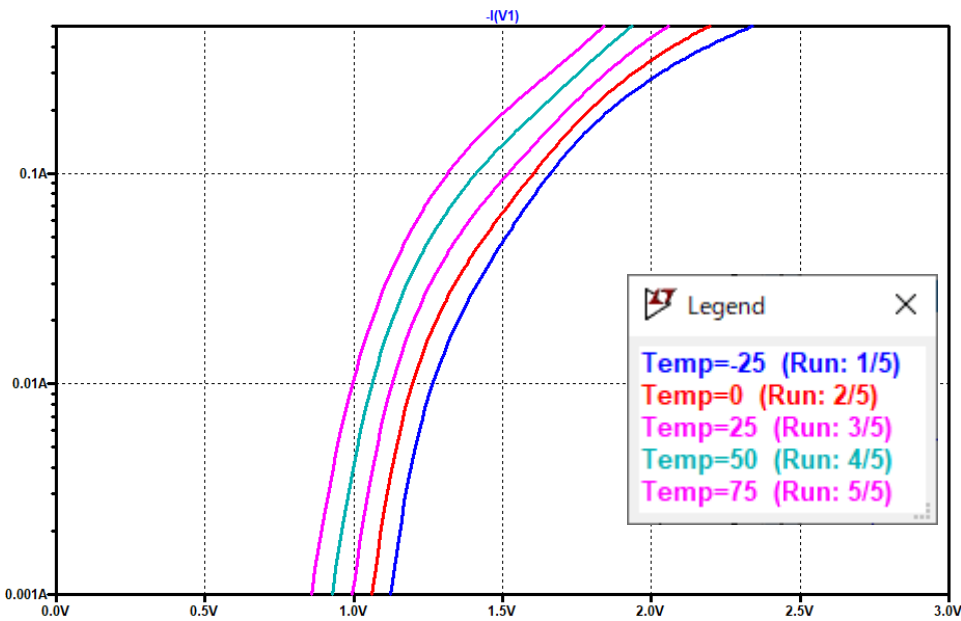
```
.OPTION TNOM=25
.TEMP -25 0 25 50 75
```

```
.dc V1 0 3 0.01
```



Simulation results are following.  
 Explanatory notes — : simulated

IF-VF



CTR-IF Testbench

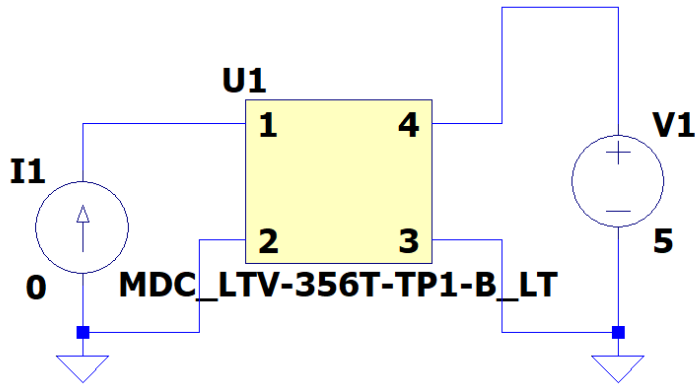
Referred to Data Sheet

**.meas Norm FIND -I(V1)/I(I1) AT 5mA**

**.OPTION TNOM=25**

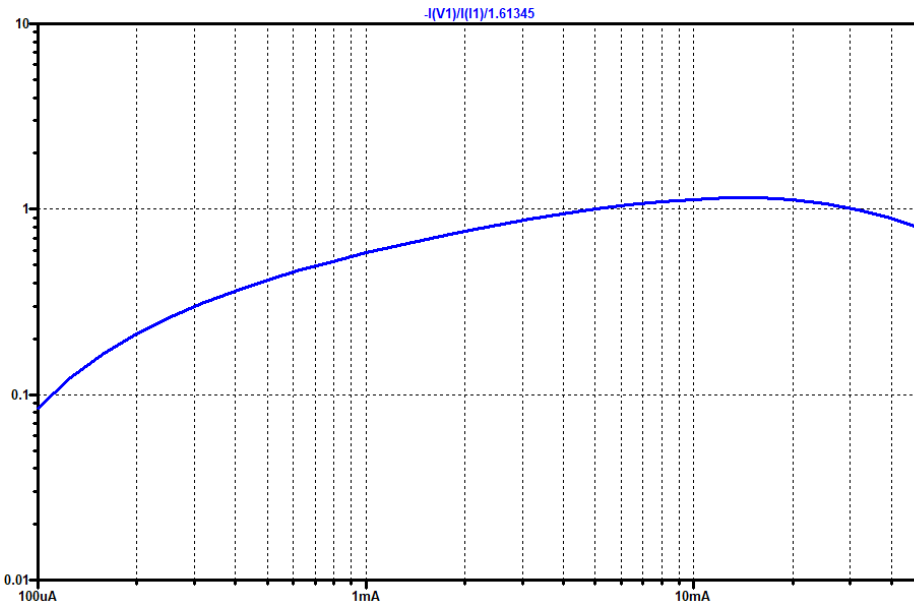
**.TEMP=25**

**.dc dec I1 0.1m 50m 10**



Simulation results are following.

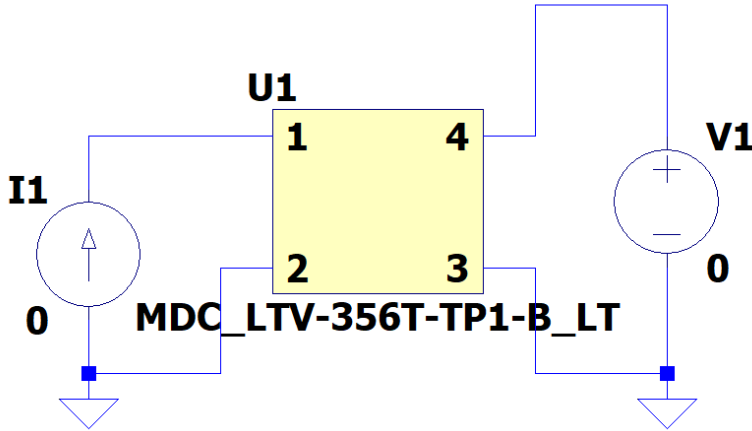
Explanatory notes — : simulated



IC-VCE Testbench

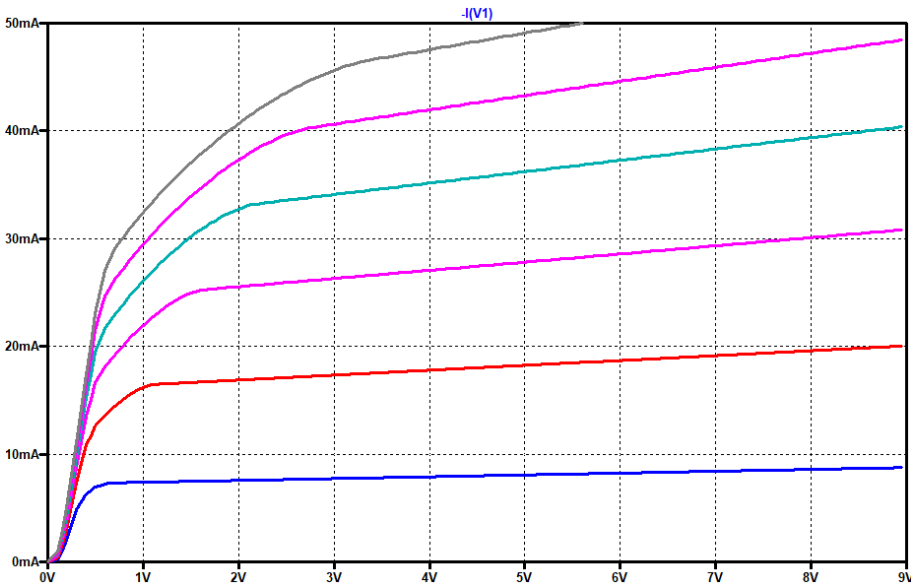
Referred to Data Sheet

```
.OPTION TNOM=25
.TEMP=25
.dc V1 0 9 0.1 I1 5m 30m 5m
```



Simulation results are following.  
 Explanatory notes — : simulated

IC-VCE

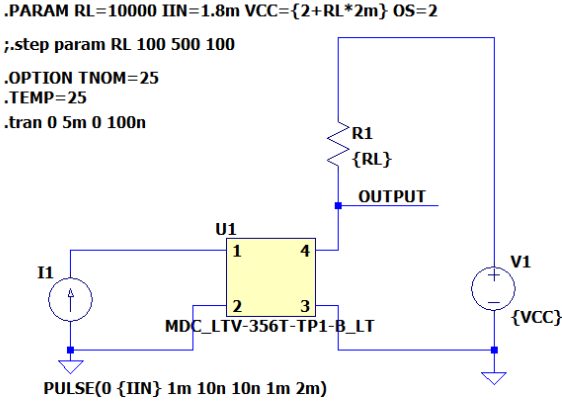


**Legend** ✕

- I1=5m (Run: 1/6)
- I1=10m (Run: 2/6)
- I1=15m (Run: 3/6)
- I1=20m (Run: 4/6)
- I1=25m (Run: 5/6)

Response Time-Load Resistance Testbench

Referred to Data Sheet



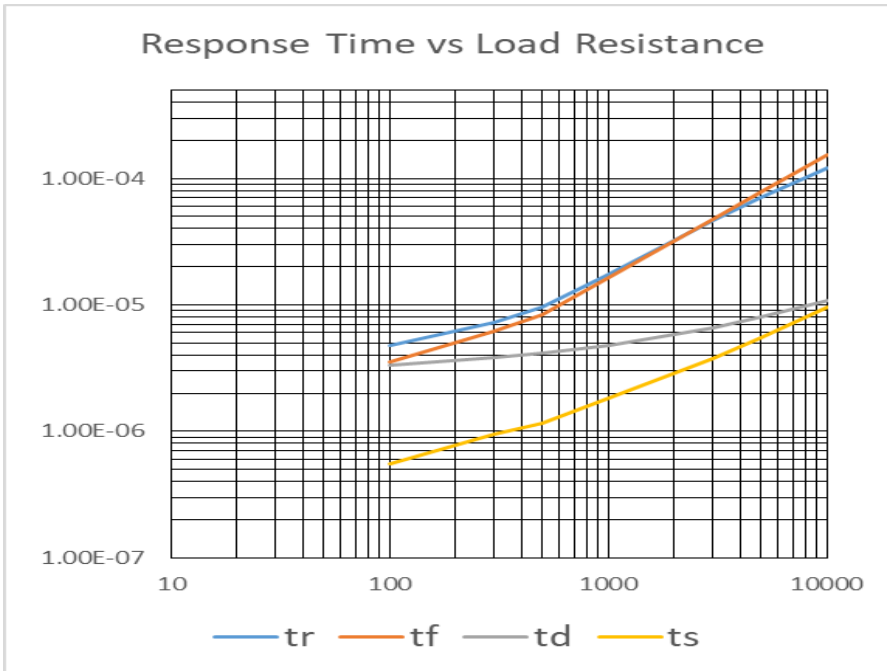
```

.meas tr TRIG V(output)={VCC-OS}*0.9+OS FALL=2 TARG V(output)={VCC-OS}*0.1+OS FALL=2
.meas tf TRIG V(OUTPUT)={VCC-OS}*0.1+OS RISE=2 TARG V(OUTPUT)={VCC-OS}*0.9+OS RISE=2
.meas td FROM 3m TARG V(output)={VCC-OS}*0.9+OS FALL=2
.meas ts FROM 4m TARG V(output)={VCC-OS}*0.1+OS RISE=2

```

Simulation results are following.  
 Explanatory notes — : simulated

Response Time-Load Resistance



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